July 2008

# FDW2503NZ

## Dual N-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

### **General Description**

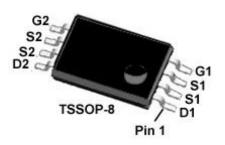
This NChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

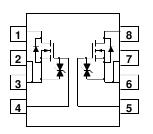
### Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

### Features

- 5.5 A, 20 V.  $R_{DS(ON)} = 20 \ m\Omega \ @V_{GS} = 4.5V$  $R_{DS(ON)} = 26 \ m\Omega \ @V_{GS} = 2.5V$
- Extended  $V_{GSS}$  range (±12V) for battery applications
- ESD protection diode (note 3)
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





### Absolute Maximum Ratings T<sub>A=25°C unless otherwise noted</sub>

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage		±12	V
b	Drain Current – Continuous	(Note 1a)	5.5	A
	- Pulsed		30	
PD	Power Dissipation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	100	°C/W
		(Note 1b)	125	

### **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
2503NZ	FDW2503NZ	13"	12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \ \mu A$	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		14		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \ V, \qquad V_{\text{GS}} = 0 \ V$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			10	μA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -12 \ V,  V_{DS} = 0 \ V$			-10	μA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6	1.0	1.5	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-3		mV/⁰C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V,  I_D = 5.5 \ A \\ V_{GS} = 2.5 \ V,  I_D = 5 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 5.5 \ A, \ T_J = 125^\circ C \end{array} $		14 19 19	20 26 29	mΩ
D(on)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	30			Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_D = 5.5 A$		30		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ ,		1286		pF
Coss	Output Capacitance	f = 1.0 MHz		305		pF
Crss	Reverse Transfer Capacitance	7		161		pF
Switchir	ng Characteristics (Note 2)	· · · ·		•	•	•
t <sub>d(on)</sub>	Turn–On Delay Time	$ \begin{array}{ll} V_{\text{DD}} = 10 \ \text{V}, & I_{\text{D}} = 1 \ \text{A}, \\ V_{\text{GS}} = 4.5 \ \text{V}, & R_{\text{GEN}} = 6 \ \Omega \end{array} $		10	20	ns
tr	Turn–On Rise Time			14	25	ns
d(off)	Turn–Off Delay Time			25	40	ns
lf	Turn-Off Fall Time	7		8	16	ns
Qg	Total Gate Charge	$ \begin{array}{ll} V_{DS} = 10 \; V, & I_{D} = 5.5 \; A, \\ V_{GS} = 4.5 \; V \end{array} $		12	17	nC
Q <sub>gs</sub>	Gate-Source Charge			2.6		nC
Q <sub>gd</sub>	Gate-Drain Charge			3		nC
Drain-S	ource Diode Characteristics a	and Maximum Ratings				
s	Maximum Continuous Drain–Source				1.0	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.0 A$ (Note 2)		0.7	1.2	V

 R<sub>0,A</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,C</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

a)  $~~R_{\rm 6JA} is~100^{\circ} C/W$  (steady state) when mounted on a 1 inch² copper pad on FR-4.

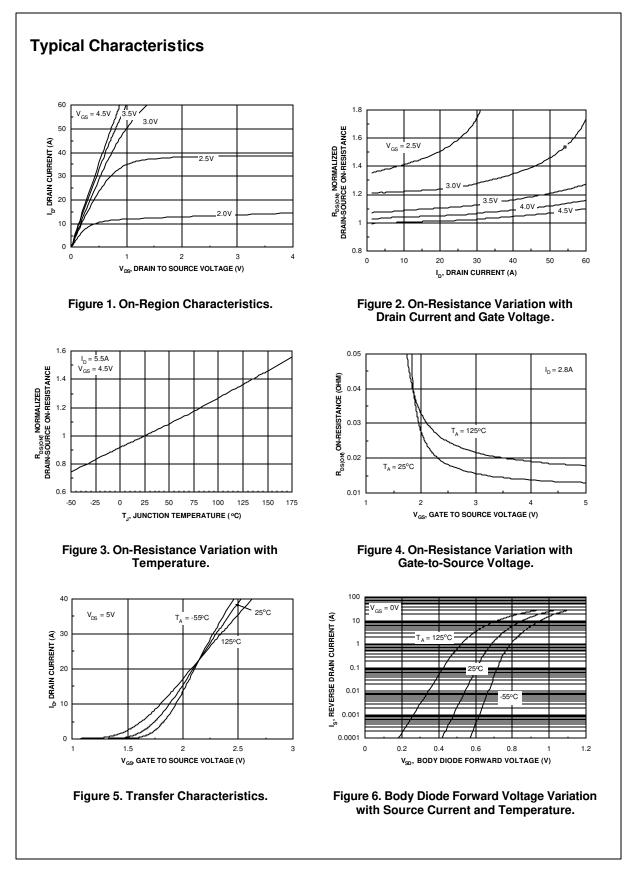
b)  $R_{\theta,JA}$  is 125°C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

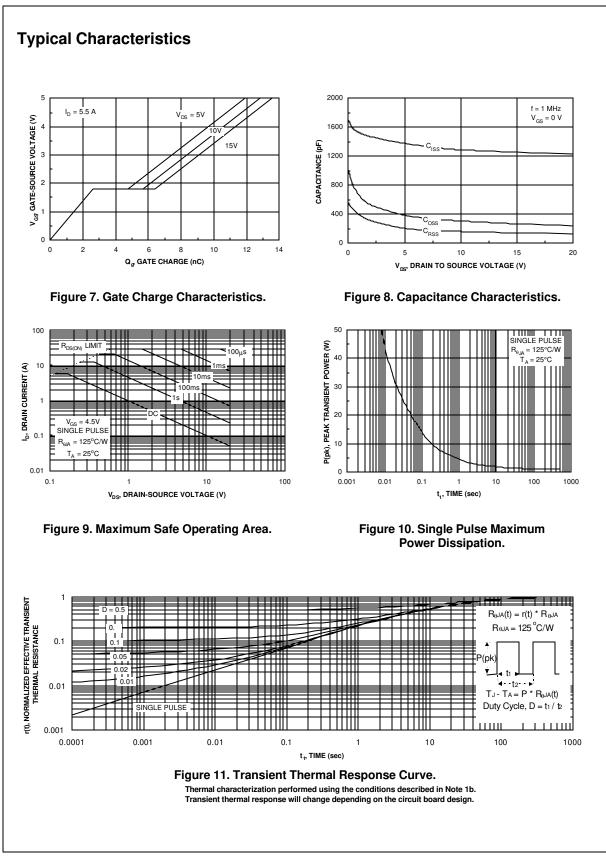
FDW2503NZ

FDW2503NZ Rev C1(W)



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